• CRU Description:

JESD cannot communication

Cross section observed suspected substrate crack at row A1



ATE Result:

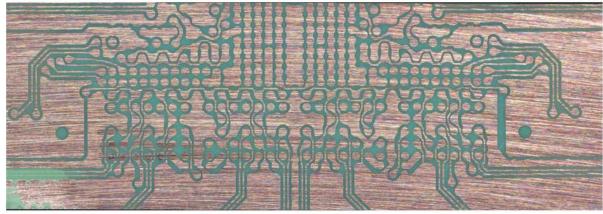
All 3 return units passed ATE test at room and high temperature at 90°C.

• Bench Result:

2pcs return units performed bench test. Customer reported fails cannot be replicated at DVDD max(0.95V) and high temperature at 100°C, but the fails duplicated only when applied DVDD higher (0.965-0.97V) than datasheet spec.

• FA Result:

2pcs fail unit + 1pcs good unit ship to shDAO for FA Cross section in shDAO didn't observe any abnormal Customer reported suspected substrate crack issue is not verified.



Reliability Result:

This device has quarterly package level reliability monitor tests, and all passed without any issue notified.

data code	Sample size	Precondition	TC250x (- 55 ~ 125° C)	TC700x ((- 55 ~ 125°C))
2004	20	IO/20 All pass electrical test	0/20_All pass for electrical test	0/18_All pass for electrical test
			0/2_No delamination	0/2_No delamination
2007	20	IN/2N All nass electrical test	0/20_All pass for electrical test	0/18_All pass for electrical test
			0/2_No delamination	0/2_No delamination
2010	20	IN/20 All pass for electrical test	0/20_All pass for electrical test	0/18_All pass for electrical test
			0/2_No delamination	0/2_No delamination
2011	20	10/20 All pass for electrical fest	0/20_All pass for electrical test	0/18_All pass for electrical test
			0/2_No delamination	0/2_No delamination

Conclusion:

In conclusion, TI could not verify the customer reported issue within TI datasheet spec and all customer returns have been deemed Trouble Not Identified (TNI).

Since the fails were duplicated only when applied DVDD higher than datasheet spec, TI recommended customer to check application conditions to ensure units were used within datasheet spec.

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